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February 26, 2001

Patrice Uchno Leland

Patrice L. Uchno Leland

AF/3743
3-6-01
Amr
S/B
(ne)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No. 09/511,292
(Attorney Docket No. H-204325)

Filed February 23, 2000

RECEIVED

James Nagashima
Terence G. Ward

Group 3743

MAR 5 - 2001

TECHNOLOGY CENTER R3700

APPARATUS AND METHOD FOR
MOUNTING A POWER MODULE

Examiner C. Atkinson

*Do not
enter*

AMENDMENT AFTER FINAL REJECTION

Commissioner for Patents
Washington DC 20231

*OK
3/7/01*

In response to the Office Action mailed January 2, 2001, please amend the above-identified application as follows:

IN THE CLAIMS:

Cancel Claim 12 and amend Claims 1 and 10 as follows:

1. (Twice Amended) A cooling assembly comprising:

a heat sinking member having a plurality of recesses defined therein, said heat sinking member receptive to liquid coolant flow;

a power module disposed on said heat sinking member, said power module having a

5 casing with plurality of indentations therein, said indentations being positioned relative to said recesses to locate said power module on said heat sinking member, and